

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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|--|---|------------------------------------|
| In re Patent Application: | : | Group Art Unit: 1775 |
| J. Fuller et al | : | Examiner: |
| Serial No.: 10/643,909 | : | Endicott Interconnect Technologies |
| Filed: 08/20/03 | : | 1701 North Street |
| Title: Circuitized Substrate and Method Of Making Same | : | Endicott, NY 13760 |

Commissioner For Patents
P.O. Box 1450
Arlington, VA 223130-1450

Sir:

STATUS INQUIRY

Applicants request the status of the above application. The application was filed on 08/20/03. A copy of the return postcard is attached for the Examiner's convenience. A Filing Receipt was received 10/28/03. A copy is also attached for the Examiner's convenience.

Because Applicants have heard nothing further as of this date, a status is requested. Please advise when we may expect a communication with respect to the above-referenced application. A stamped, self-addressed envelope is enclosed herewith for your use in responding to this request.

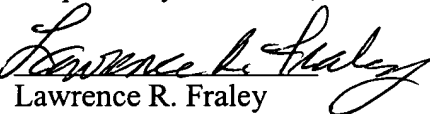
An e-mail response to the undersigned at the email address below or a phone response is encouraged to expedite a response to this inquiry.

Telephone: (561) 575-3608
Fax : (561) 745-2741

EI-2-03-009

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Respectfully submitted,



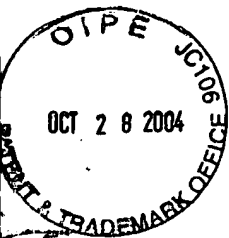
Lawrence R. Fraley

Reg. No: 26,885

Attorney for Applicants

Date: 10/26/04

e-mail: Lawrence.Fraley@eitny.com



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SEP 03 2003

Date: 8/19/03

~~Express Mail No.~~ Airborne Airbill #5994945865

Please Acknowledge and Return

- | | |
|---|--|
| <input checked="" type="checkbox"/> Application | <input type="checkbox"/> Issue Fee |
| <input checked="" type="checkbox"/> Declaration <u>2</u> pgs. | <input type="checkbox"/> Draftsman w/Dwgs. |
| <u>X</u> signed <u> </u> unsigned | <input checked="" type="checkbox"/> Cert. Of Mailing |
| <input checked="" type="checkbox"/> Assignment w/Cover Pg. | <input type="checkbox"/> |
| <input checked="" type="checkbox"/> IDS/PTO-1449/Refs. | |
| <input type="checkbox"/> Amendment | |

Title Circuitized Substrate And Method Of Making Same

12 Pgs. Spec. 18 Claims 0 Shts. Of Drawing
\$750.00 Filling Fee Attorney Lawrence R. Fraley
Docket EI-2-03-009
In Appln. Of Foster et al
Serial/Inter. Number
Filed Herewith

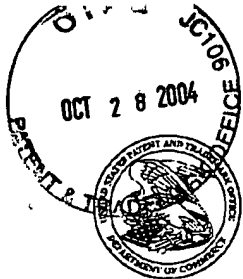
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10/643909



08/20/03

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| APPL NO. | FILING OR 371 (c) DATE | ART UNIT | FIL FEE REC'D | ATTY. DOCKET NO | DRAWINGS | TOT CLMS | IND CLMS |
|------------|---------------------------|----------|---------------|-----------------|----------|----------|----------|
| 10/643,909 | 08/20/2003 | 1775 | 750 | EI-2-03-009 | | 18 | 2 |

CONFIRMATION NO. 4754

Lawrence R. Fraley
 IP Law Counsel
 Endicott Interconnect Technologies, Inc.
 1701 North Street, FBU/257-2 AA12
 Endicott, NY 13760

FILING RECEIPT

OC000000012506969

Date Mailed: 05/03/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Elizabeth Foster, Friendsville, PA;
 Gregory Kevern, Endwell, NY;
 Anita Sargent, Endwell, NY;

Assignment For Published Patent Application

Endicott Interconnect Technologies, Inc., Endicott, NY;

Domestic Priority data as claimed by applicant**Foreign Applications**

If Required, Foreign Filing License Granted: 04/27/2004

Projected Publication Date: 02/24/2005

Non-Publication Request: No

Early Publication Request: No

Title

Circuitized substrate and method of making same



IFW

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**Commissioner For Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450**

On 10/26/04.

Christine Lang
Signature

Christine Lang
Typed or printed name of person of signing Certificate

EI-2-03-009 – Status Inquiry, copy of return postcard, copy of filing receipt.

Note: Each paper must have its own certificate of mailing, or this certificate must identify each submitted paper.